

## **Product Specification**

Model Name	S080QXG04EA			
	TFT LCD Module(Standard Model)			
Description	8.0" XGA			
	1024(RGB)x768 Dots			
Date	2016/10/10			
Version	2.0			

Approved	Check	Prepared			
by/Date	by/Date	by/Date			
Sam 2016/10/10	Borger 2016/10/10	Li Huang 2016/10/10			

	Customer Approval					
Date						

### **Table of Contents**

1. Record of Revision	
2. General Specifications	4
3. Input/Output Terminals	
4. Absolute Maximum Rating	
5. Electrical characteristics	
6. Optical Characteristics	14
7. Environmental / Reliability Tests	
8. Mechanical Drawing	19
9. Packing	
10. TFT-LCD Module Inspection Criteria	21
11. Precautions for Use of LCD modules	26

### 1. Record of Revision

Rev	Issued Date	Description	Editor
1.0	2016/08/29	First Release.	Li Huang
2.0	2016/10/10	Update PN	Jack Guo



### 2. General Specifications

	Feature	Spec		
	Size	8.0 inch		
	Resolution	1024(horizontal)*768(Vertical)		
	Size Resolution Interface Connect type Display Colors Technology type Pixel pitch (mm) Pixel Configuration Display Mode Driver IC Viewing Direction LCM (W x H x D) (mm) Active Area(mm) Weight (g)	LVDS		
		Connector		
	Display Colors	16.7M		
Characteristics	Technology type	a-Si		
	Pixel pitch (mm)	0.1583*0.1583		
	Pixel Configuration	R.G.BStripe		
	Display Mode	Normally Black		
	Driver IC	TBD		
	Viewing Direction	Full view		
	LCM (W x H x D) (mm)	183.00*141.00*6.15		
Mechanical	Active Area(mm)	162.05*121.54		
iviechanicai	Weight (g)	169 g		
	LED Numbers	27 LEDs		

Note 1: Requirements on Environmental Protection: RoHs

Note 2: LCM weight tolerance: +/- 5%



### 3. Input/Output Terminals

No.	Symbol	Description
1	VCOM	Common voltage
2	VDD	3.3V Power
3	VDD	3.3V Power
4	NC	Not connect
5	RESET	Global reset pin Active low enter reset state Suggest to connecting with an RC reset Normally pull hight(R=100K,C=1UF)
6	STBYB	Standby mode normally pull high STBYB="1",timing control ,source driver will turn off all output are high-Z
7	GND	System Ground
8	RXIN0-	Negative LVDS differential data input
9	RXIN0+	Positive LVDS differential data input
10	GND	System Ground
11	RXIN1-	Negative LVDS differential data input
12	RXIN1+	Positive LVDS differential data input
13	GND	System Ground
14	RXIN2-	Negative LVDS differential data input
15	RXIN12+	Positive LVDS differential data input
16	GND	System Ground
17	RXCLK-	Negative LVDS differential clock input
18	RXCLK+	Positive LVDS differential clock input
19	GND	System Ground
20	RXIN3-	Negative LVDS differential data input
21	RXIN3+	Positive LVDS differential data input
22	GND	System Ground
23	NC	Not connect
24	NC	Not connect
25	GND	System Ground
26	NC	Not connect
27	DIMO	Backlight CABC controller signal output
28	SELB	6bit/8bit mode select H:6bit /L:8bit Note1
29	AVDD	Power for Analog Circuit
30	GND	System Ground
31	NC(LED-)	Not connect
32	NC(LED-)	Not connect



33	L/R	Horizontal inversion	Note3
34	U/D	Vertical inversion	Note3
35	VGL	Positive power for TFT	
36	CABCEN1	CABC H/W enable	Note2
37	CABCEN0	CABC H/W enable	Note2
38	VGH	Positive power for TFT	
39	NC(LED+)	Not connect	
40	NC(LED+)	Not connect	

I: input, O: output, P: Power

Note1: If LVDS input data is 6 bits, selb must be set to High;

If LVDS input data is 8 bits, selb must be set to Low.

Note2: When CABC EN="00", CABC OFF.

When CABC\_EN="01", user interface image.

When CABC EN="10", still picture.

When CABC\_EN="11", moving image.

When CABC off, don't connect DIMO, else connect it to backlight.

Note3: When L/R="0", set right to left scan direction.

When L/R="1", set left to right scan direction.

When U/D="0", set top to bottom scan direction.

When U/D="1", set bottom to top scan direction.

### 4. Absolute Maximum Rating

Item	Symbol	MIN	Тур	MAX	Unit	Remark
Supply Voltage	$V_{DD}$	-0.3	-	5	V	-
Operating Temperature	T <sub>OPR</sub>	-20	-	70	$^{\circ}$ C	-
Storage Temperature	T <sub>STG</sub>	-30	-	70	$^{\circ}$	

### 5. Electrical characteristics

### 5.1 Driving TFT LCD Panel

Item	Symbol	MIN	TYP	MAX	Unit	Remark
	Vcc	3.0	3.3	3.6	V	-
_ "	AVDD	9.8	10	10.2	V	-
Power voltage	VgH	18.6	18.9	19.2	V	-
	VgL	8.1	7.8	7.5	V	-
Input signal voltage	Vсом	2.6	3.6	4.6	V	-
Input logic high voltage	ViH	0.7Vcc	-	Vcc	V	
Input logic low voltage	VIL	-	-	0.3Vcc	V	-

Note 1: Be sure to apply VCC and VGL to the LCD first, and then apply VGH.

Note 2: VCC setting should match the signals output voltage (refer to Note 3) of customer's system board.

Note 3: Typical Vcom is only a reference value; it must be optimized according to each

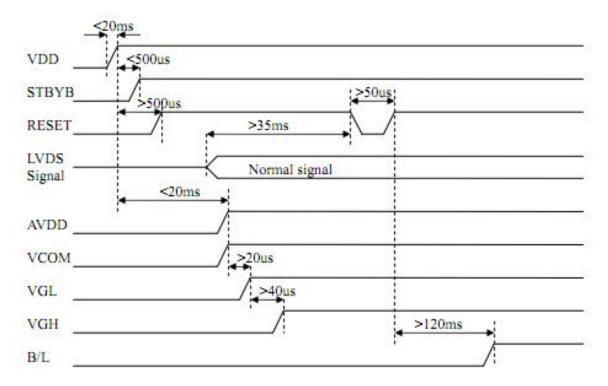
LCM, please use VR and base on below application circuit.

Note 4: Reset, stbyb, selb, L/R, U/D, cabcen0, cabcen 1.

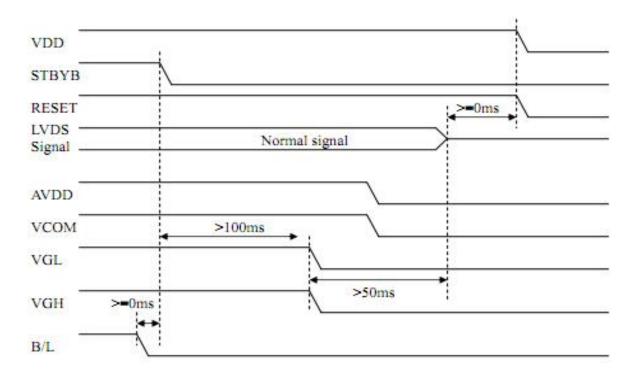


### **5.2 Power ON.OFF sequence**

#### 5.2.1. Power on:



### 5.2.2. Power off:



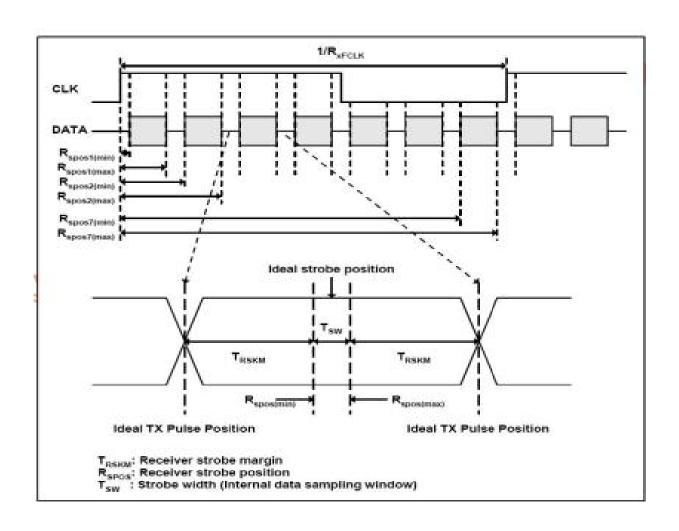


### **5.3 Timing Characteristics**

### 5.3.1 AC electrical characteristics

Parameter	Cumbal		Values	Hait	Remark	
	Symbol	Min. Typ.		Max.		Unit
Clock frequency	R <sub>xFCLK</sub>	20	950	71	MHz	
Input data skew margin	T <sub>RSKM</sub>	500	2.4	- 1	ps	
Clock high time	T <sub>LVCH</sub>	180	4/(7* R <sub>xFCLK</sub> )	-	ns	
Clock low time	TLVCL	1940	3/(7* RxFCLK)	-	ns	

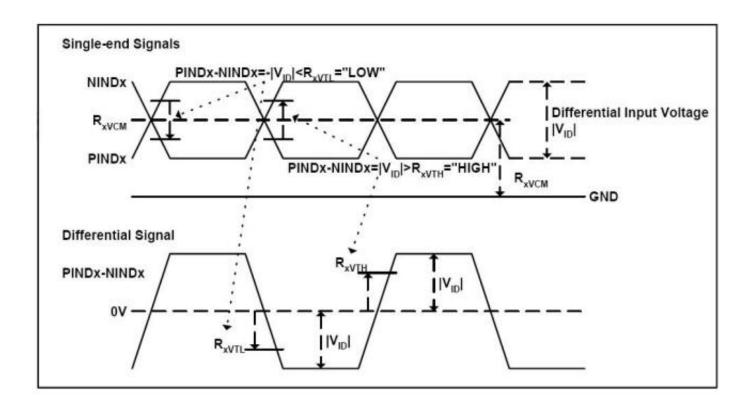
### 5.3.2. Input Clock and Data Timing Diagram





### 5.3.2 DC Electrical Characteristics

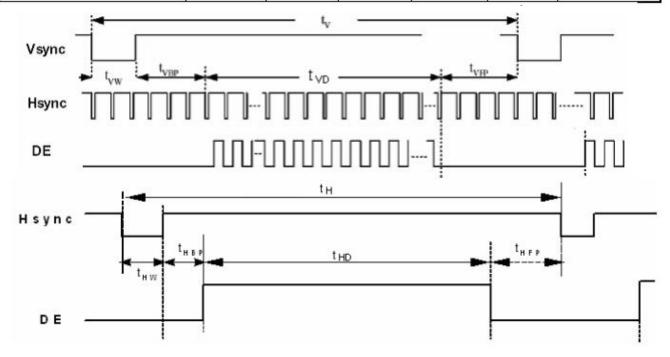
Parameter	Symbol		Value	Unit	Remark	
1 diameter	Gyillboi	Min.	Typ.	Max.	Oiiit	Kemark
Differential input high Threshold voltage	R <sub>xVTH</sub>	-		+0.1	V	
Differential input low Threshold voltage	R <sub>xVTL</sub>	-0.1	141	÷	V	
Input voltage range (singled-end)	R <sub>xVIN</sub>	0	5.0	2.4	V	
Differential input common mode voltage	R <sub>xVCM</sub>	V <sub>ID</sub>  /2		2.4- V <sub>ID</sub>  /2	٧	
Differential voltage	V <sub>ID</sub>	0.2	•	0.6	V	
Differential input leakage current	RV <sub>xliz</sub>	-10	(2)	+10	uA	





### 5.3.3 Timing Diagram

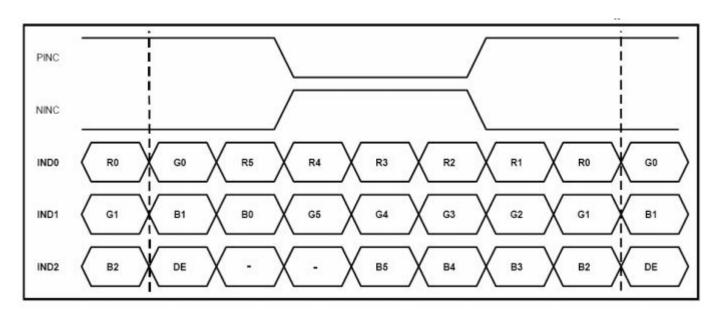
	0		Values			
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Clock Frequency	fclk	52	65	71	MHz	Frame rate =TBD
Horizontal display area	thd	j.	1024	P.C.	5	*
HS period time	th	1114	1344	1400	DCLK	
HS Blanking	thb+thfp	90	320	376	DCLK	
Vertical display area	tvd	<i>y</i> :	768	D. 1.		
VS period time	tv	778	806	845	Н	
VS Blanking	tvb+tvfp	10	38	77	Н	



3.3.5. Data Input Format

6bit LVDS input





### **5.4 LED Driving Conditions**

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	$I_{\mathrm{F}}$	-	540	585	mA	
Forward Voltage	$V_{\mathrm{F}}$	-	9.6	9.9	V	
Backlight Power consumption	$W_{ m BL}$	-	5.18	5.79	W	
LED Lifetime		50000	-	-	Hrs	

Note 1: Each LED: IF =60 mA, VF =3.2+/0.2V.

Note 2: Optical performance should be evaluated at Ta=25°C only.

Note 3: If LED is driven by high current, high ambient temperature & humidity condition. The life Time of LED will be reduced. Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.

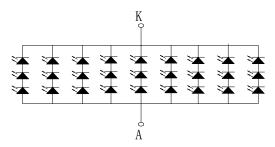


Figure: LED connection of backlight(Constant Current)



### 6. Optical Characteristics

Items	<b>;</b>	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note
Response time		Tr+Tf		-	25	50	ms	FIG.1	Note4
Contrast Ratio		CR	-		800	-	-	FIG.2	Note1
Surfac luminan		LV	θ <b>=0</b> °	900	1000	-	cd/m2	FIG.2	Note2
Luminar uniform		Yu	θ <b>=0°</b>	80	-	-	%	FIG.2	Note3
			∅=90°	-	85	-	deg	FIG.3	
Viouing a	Viewing angle		∅=270°	-	85	-	deg	FIG.3	Note6
viewing a			∅ <b>=</b> 0°	ı	85	1	deg	FIG.3	Noteo
			∅=180°	-	85	-	deg	FIG.3	
	Red	R <sub>X</sub>		TBD	TBD	TBD	-		
	Reu	R <sub>Y</sub>	0 -00	TBD	TBD	TBD	-		
	0	G <sub>X</sub>	θ =0°	TBD	TBD	TBD	-		
Chromaticity	Green	G <sub>Y</sub>	∅=0°	TBD	TBD	TBD	-	FIG.2	Note5
	Rluc	B <sub>X</sub>	B <sub>X</sub>	Ta=25°	TBD	TBD	TBD	-	CIE1931
	Blue	B <sub>Y</sub>	1a-25	TBD	TBD	TBD	-		
	White	W <sub>X</sub>		0.26	0.31	0.36	-		
	VVIIILE	W <sub>Y</sub>		0.28	0.33	0.38	-		

#### Note1. Definition of contrast ratio

Contrast ratio(Cr) is defined mathematically by the following formula. For more information see FIG.2.

Luminance measured when LCD on the "White" state

Contrast ratio=

Luminance measured when LCD on the "Black" state

For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on TOPCON's BM-5 or BM-7 photo detector or compatible.

#### Note2. Definition of surface luminance.

Surface luminance is the luminance with all pixels displaying white. For more information see FIG.2.

Lv = Average Surface Luminance with all white pixels(P1,P2,P3, .....,Pn)

#### **Note3. Definition of luminance uniformity**

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance. For more information see FIG.2.

Minimum surface luminance with all white pixels (P1,P2,P3,.....,Pn)

Maximum surface luminance with all white pixels (P1,P2,P3,.....,Pn)

### **Note4. Definition of response time**

The response time is defined as the LCD optical switching time interval between "White" state and "Black"state. Rise time (Tr) is the time between photo detector output intensity changed from 90% to 10%. And fall time (Tf) is the time between photo detector output intensity changed from 10% to 90%. For additional information see FIG1.

#### Note5. Definition of color chromaticity (CIE1931)

CIE (x,y) chromaticity, The x,y value is determined by screen active area center position P5. For more information see FIG.2.

#### Note6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. Angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG.3.

For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible.



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#### FIG.1.The definition of response Time

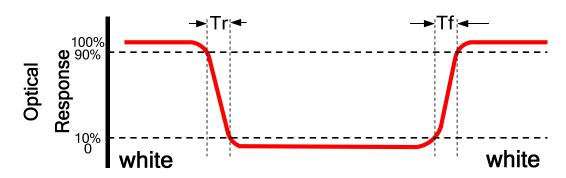


FIG.2. Measuring method for contrast ratio, surface luminance,

### luminance uniformity, CIE (x,y) chromaticity

Size: S≤5"(see Figure a) A: 5 mm B: 5 mm

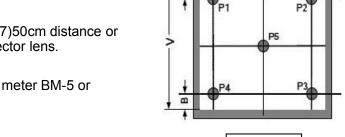
H,V: Active area

Light spot size  $\oslash$ =5mm(BM-5) or  $\oslash$ =7.7mm (BM-7)50cm distance or compatible distance from the LCD surface to detector lens.

test spot position : see Figure a.

measurement instrument: TOPCON's luminance meter BM-5 or

BM-7 or compatible (see Figure c).



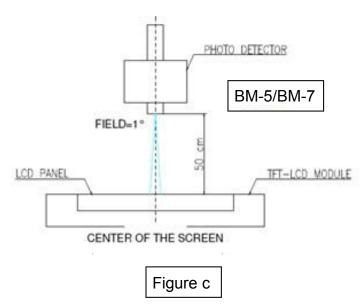
Size : 5" < S≤12.3"(see Figure b) H,V : Active area

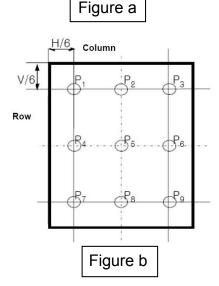
Light spot size ∅=5mm(BM-5) or ∅=7.7mm (BM-7)50cm distance or compatible distance from the LCD surface to detector lens.

test spot position : see Figure b.

measurement instrument : TOPCON's luminance meter BM-5 or

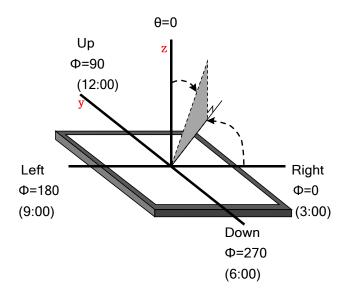
BM-7 or compatible (see Figure c).







### FIG.3.The definition of viewing angle





### 7. Environmental / Reliability Tests

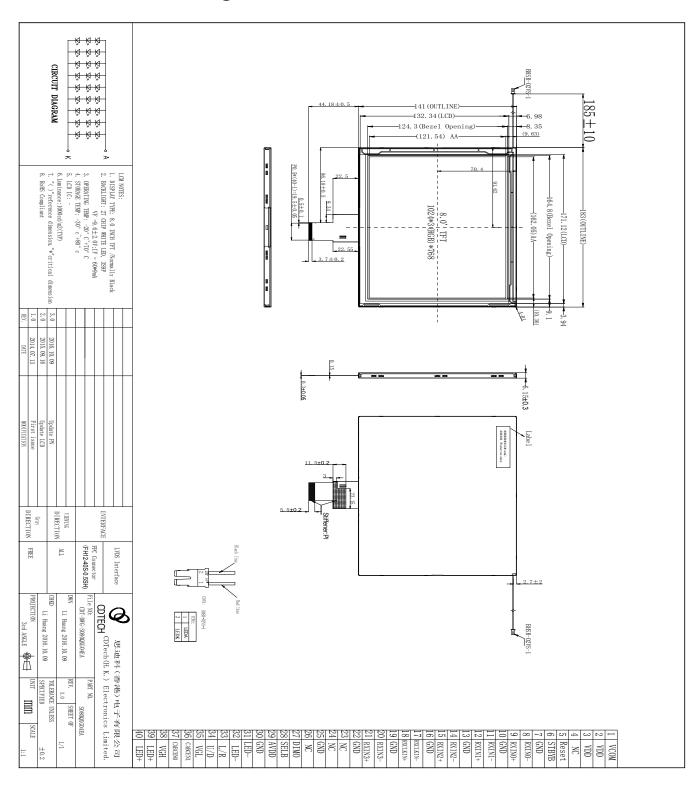
No	Test Item	Condition	Remarks
	High Temperature	T 70°C 00h	Note 1
1	Operation	Ts= +70°C, 96hrs	IEC60068-2-2, GB2423. 2-89
2	Low Temperature Operation	Ta= -20℃, 96hrs	Note 2 IEC60068-2-1 GB2423.1-89
3	High Temperature Storage	Ta= +80°C, 120hrs	IEC60068-2-2 GB2423. 2-89
4	Low Temperature Storage	Ta= -30℃, 120hrs	IEC60068-2-1 GB/T2423.1-89
5	High Temperature & Humidity Storage	Ta= +60℃, 90% RH max,120 hours	IEC60068-2-3 GB/T2423.3-2006
6	Thermal Shock (Non-operation)	-20℃ 30 min ~ +60℃ 30 min Change time: 5min, 30 Cycle	Start with cold temperature, end with high temperature IEC60068-2-14, GB2423.22-87
7	Electro Static Discharge (Operation)	charge Air:±8KV, 5 times; Contact: ±4KV, 5 times; (Environment: 15°C ~	
8	Vibration (Non-operation)	F	
9	Shock (Non-operation)	60G 6ms, ± X, ±Y , ± Z 3 times for each direction	IEC60068-2-27 GB/T2423.5-1995
10	Package Drop Test	Height: 80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32 GB/T2423.8-1995

Note:1. Ts is the temperature of panel's surface.

- 2. Ta is the ambient temperature of sample.
- 3. The size of sample is 5pcs.



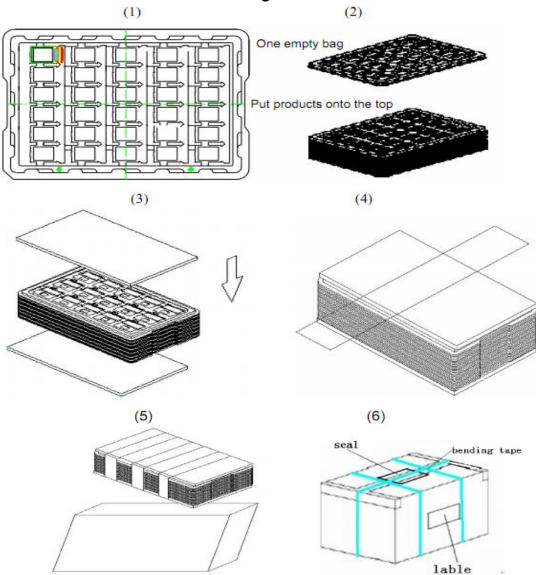
### 8. Mechanical Drawing





### 9. Packing

### Packing Method



- 1. Put module into tray cavity:
- 2. Tray stacking
- 3. Put 1 cardboard under the tray stack and 1 cardboard above:
- 4. Fix the cardboard to the tray stack with adhesive tape:
- 5. Put the tray stack into carton.
- 6. Carton sealing with adhesive tape.

### 10. TFT-LCD Module Inspection Criteria

### 10.1 Scope

The incoming inspection standards shall be applied to TFT - LCD Modules (hereinafter Called "Modules") that supplied by CDTech Technology LTD.

### 10.2 Incoming Inspection

The customer shall inspect the modules within twenty calendar days of the delivery date (the "inspection period) at its own cost. The result of the inspection (acceptance or rejection) shall be recorded in writing, and a copy of this writing will be promptly sent to The seller, If the results of the inspecting from buyer does not send to the seller within twenty Calendar days of the delivery date. The modules shall be regards as acceptance. Should the customer fail to notify the seller within the inspection period, the buyers Right to reject the modules shall be lapsed and the modules shall be deemed to have Been accepted by the buyer

### 10.3 Inspection Sampling

3.1. Lot size: Quantity per shipment lot per model

3.2. Sampling type: Normal inspection, Single sampling

3.3. Inspection level: II

3.4. Sampling table: MIL-STD-105E

3.5. Acceptable quality level (AQL)

Major defect: AQL=0.65 Minor defect: AQL=1.00

### **10.4 Inspection Conditions**

4.1 Ambient conditions:

a. Temperature: Room temperature 25±5℃

b. Humidity:  $(60\pm10)$  %RH

c. Illumination: Single fluorescent lamp non-directive (300 to 700 Lux)

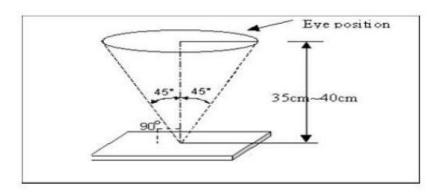
4.2 Viewing distance

The distance between the LCD and the inspector's eyes shall be at least  $35\pm5$  cm.

4.3 Viewing Angle

U/D: 45 ° /45° , L/R: 45° /45°





### 10.5 Inspection Criteria

Defects are classified as major defects and minor defects according to the degree of Defectiveness defined herein.

### 10.5.1 Major defect

	<u> </u>	
Item No	Items to be inspected	Inspection Standard
5.1.1	All functional defects	1) No display 2) Display abnormally 3) Short circuit 4) line defect
`5.1.2	Missing	Missing function component
5.1.3	Crack	Glass Crack

#### 10.5.2 Minor defect

Item No	Items to be inspected	Inspection standard		
5.2.1	Spot Defect Including Black spot White spot Pinhole Foreign	For dark/white spot is defined $\varphi = (x+y) / 2$ $\longrightarrow \begin{array}{c} X \\ \downarrow \\ \chi \end{array}$		
	particle	Size φ(mm)	Acceptable Quantity	
	Polarizer dirt	φ≤0.2	Ignore	
		0.2 < φ≤0.5	3	
		0.5< ф	Not allowed	

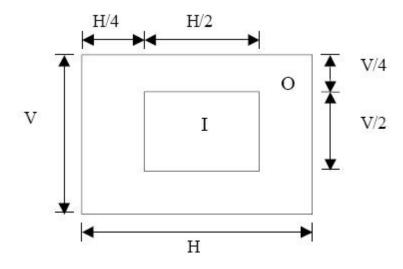


		Define:    Y   Width	h			
5.2.2	Line Defect Including Black line White line Scratch	Width(mm) Length(mm)	Accepta	ble Quantity		
		W≤0.05	I	gnore		
		0.05 < W≤0.1 L≤2.5		3		
		0.1 < W, or L>2.5	Not	allowed		
		Sizeφ(mm)	Accepta	ble Quantity		
		φ ≤0.2	I	gnore		
5.2.3	Polarizer	0.2 < φ≤0.3		2		
3.2.3	Dent/Bubble	$0.3 < \phi \leq 0.5$	1			
		0.5 < Φ	allowed			
		Total QTY 3				
		Bright and Black dot define:				
		英點 and				
5.2.4	Electrical Dot Defect					
		Two Adjacent Dot				
		Inspection pattern: Full white. Fu				
		Item		ble Quantity		
		Dlask dot defect	I O 2	Note  d ≤ 0.15		
		Black dot defect	1	φ≤0.15 (5mm≤Distance)		
		Bright dot defect  Total Dot	1	(Smin \Distance)		
		Total Dut	1	l		



		1.Corner Fragment:	Z. Y
		Size(mm)	Acceptable Quantity
		X≤3mm Y≤1mm	Ignore T: Glass thickness
		Y ≤ 1 mm Z ≤ T	X: Length
			Y: Width
5.2.5	Glass defect		Z: thickness
		2. Side Fragment:	
		Size(mm)	Acceptable Quantity
		X≤5.0mm	T: Glass thickness
		Y ≤1mm	X: Length
		Z≤T	Y: Width
			Z: thickness





I area & O area

Note: 1). Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area.

- 2). The distance between two bright dot defects (red, green, blue, and white) should be larger than 15mm.
- 3). The distance between black dot defects or black and bright dot defects should be more than 5mm apart.
- 4). Polarizer bubble is defined as the bubble appears on active display area. The defect of polarizer bubble shall be ignored if the polarizer bubble appears on the outside of active display area.

### 10.6 Mechanics specification

As for the outside dimension, weight of the modules, please refer to product specification For more details

### 11. Precautions for Use of LCD modules

### 11.1 Handling Precautions

- 11.1.1. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 11.1.2. If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 11.1.3. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 11.1.4. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 11.1.5. If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
  - Isopropyl alcohol
  - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketene
- Aromatic solvents
- 11.1.6. Do not attempt to disassemble the LCD Module.
- 11.1.7. If the logic circuit power is off, do not apply the input signals.
- 11.1.8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- 11.1.8.1. Be sure to ground the body when handling the LCD Modules.
- 11.1.8.2. Tools required for assembly, such as soldering irons, must be properly ground.
- 11.1.8.3. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 11.1.8.4. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

### 11.2 Storage Precautions

- 11.2.1. When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 11.2.2. The LCD modules should be stored under the storage temperature range If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0°C ~ 40°C Relatively humidity: ≤80%

11.2.3. The LCD modules should be stored in the room without acid, alkali and harmful gas.



### **11.3 Transportation Precautions**

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.